



DMN2019UTS

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| V _{(BR)DSS} | R _{DS(ON)} max | I _D max T _A = 25°C | | |
|----------------------|--------------------------------|---------------------------------------------|--|--|
| 20V | 18.5mΩ @ V _{GS} = 10V | 5.4 A | | |
| | 21mΩ @ V _{GS} = 4.5V | 5.0 A | | |
| | 24mΩ @ V _{GS} = 2.5V | 4.6 A | | |
| | 31mΩ @ V _{GS} = 1.8V | 3.5 A | | |

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

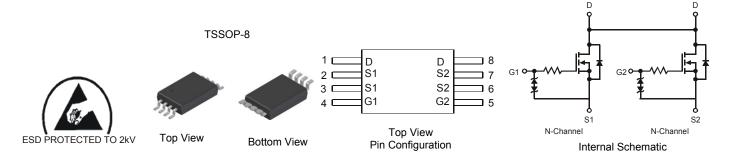
- Power management functions
- Load Switch

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected up to 2KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: TSSOP-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.039 grams (approximate)



Ordering Information (Note 4)

| Part Number | Case | Packaging | | |
|---------------|---------|------------------|--|--|
| DMN2019UTS-13 | TSSOP-8 | 2500/Tape & Reel | | |

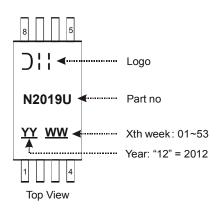
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | | |
|-----------------------------------------------------------|------------------|--------------------------------------------------|------------------|------------|---|
| Drain-Source Voltage | V _{DSS} | 20 | V | | |
| Gate-Source Voltage | | | V _{GSS} | ±12 | V |
| Continuous Drain Current (Note 5) V _{GS} = 10V | Steady State | T _A = +25°C T _A = +70°C | ID | 5.4 4.3 | A |
| Continuous Drain Current (Note 5) V_{GS} = 2.5V | Steady State | T _A = +25°C T _A = +70°C | ID | 4.6 3.7 | А |
| Continuous Body Diode Forward Current (Note 5) | Steady Stat | T _A = +25°C | Is | 0.9 | А |
| Pulsed Drain Current (Note 5) 10µs pulse, duty cycle = 1% | | | I _{DM} | 30 | А |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units |
|--------------------------------------------------|----------------------------------|-------------|-------|
| Total Power Dissipation (Note 5) | PD | 0.78 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{0JA} | 161 | °C/W |
| Thermal Resistance, Junction to Case (Note 5) | $R_{	ext{	heta}JC}$ | 26 | °C/W |
| Operating and Storage Temperature Range | T _{J,} T _{STG} | -55 to +150 | °C |

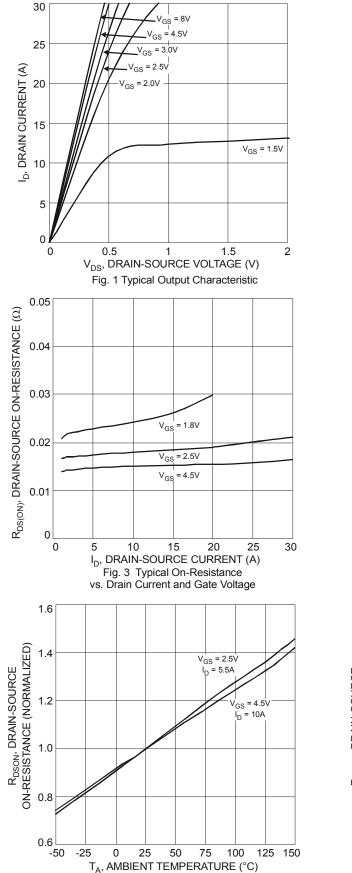
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Мах | Unit | Test Condition | |
|-----------------------------------|----------------------|------|------|------|------|-------------------------------------------------------------------------------|--|
| OFF CHARACTERISTICS (Note 6) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 20 | - | - | V | V _{GS} = 0V, I _D = 250µA | |
| Zero Gate Voltage Drain Current | IDSS | - | - | 1.0 | μA | $V_{DS} = 20V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | - | - | 10 | μA | $V_{GS} = \pm 10V, V_{DS} = 0V$ | |
| Gate-Source Breakdown Voltage | BV _{SGS} | ±12 | - | - | V | $V_{DS} = 0V, I_G = \pm 250 \mu A$ | |
| ON CHARACTERISTICS (Note 6) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.35 | - | 0.95 | V | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | |
| | | | 15.5 | 18.5 | | V _{GS} = 10V, I _D = 7A | |
| | | | 16.5 | 21 | | V _{GS} = 4.5V, I _D = 7A | |
| | | - | 17 | 21.5 | | V _{GS} = 4.0V, I _D = 7A | |
| Static Drain-Source On-Resistance | R _{DS (ON)} | - | 17.5 | 22.5 | mΩ | V_{GS} = 3.6V, I_{D} = 6.5A | |
| | | - | 18 | 23 | | V _{GS} = 3.1V, I _D = 6.5A | |
| | | - | 19 | 24 | | V _{GS} = 2.5V, I _D = 5.5A | |
| | | - | 24 | 31 | | V _{GS} = 1.8V, I _D = 3.5A | |
| Forward Transfer Admittance | Y _{fs} | - | 13 | - | S | V _{DS} = 5V, I _D = 5A | |
| Diode Forward Voltage | V _{SD} | - | 0.7 | 1.0 | V | V _{GS} = 0V, I _S = 1A | |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | | |
| Input Capacitance | Ciss | - | 143 | - | pF | | |
| Output Capacitance | Coss | - | 74 | - | pF | V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | - | 29 | - | pF | 1 - 1.000112 | |
| Gate Resistance | Rg | - | 202 | - | Ω | V_{DS} = 0V, V_{GS} = 0V, f = 1MHz | |
| Total Gate Charge | Qg | - | 8.8 | - | nC | V _{GS} = 4.5V, V _{DS} = 10V, | |
| Gate-Source Charge | Q _{gs} | - | 1.4 | - | nC | | |
| Gate-Drain Charge | Q _{gd} | - | 3.0 | - | nC | | |
| Turn-On Delay Time | t _{D(on)} | - | 53 | - | ns | V_{DD} = 10V, V_{GS} = 4.5V, R _L = 10Ω, R _G = 6Ω | |
| Turn-On Rise Time | tr | - | 78 | - | ns | | |
| Turn-Off Delay Time | t _{D(off)} | - | 562 | - | ns | | |
| Turn-Off Fall Time | t _f | - | 234 | - | ns | | |

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Berker mounted of the substate to board, but copper, with
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.





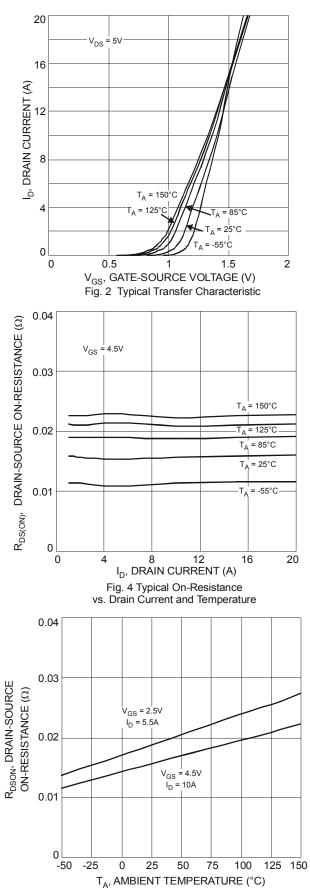
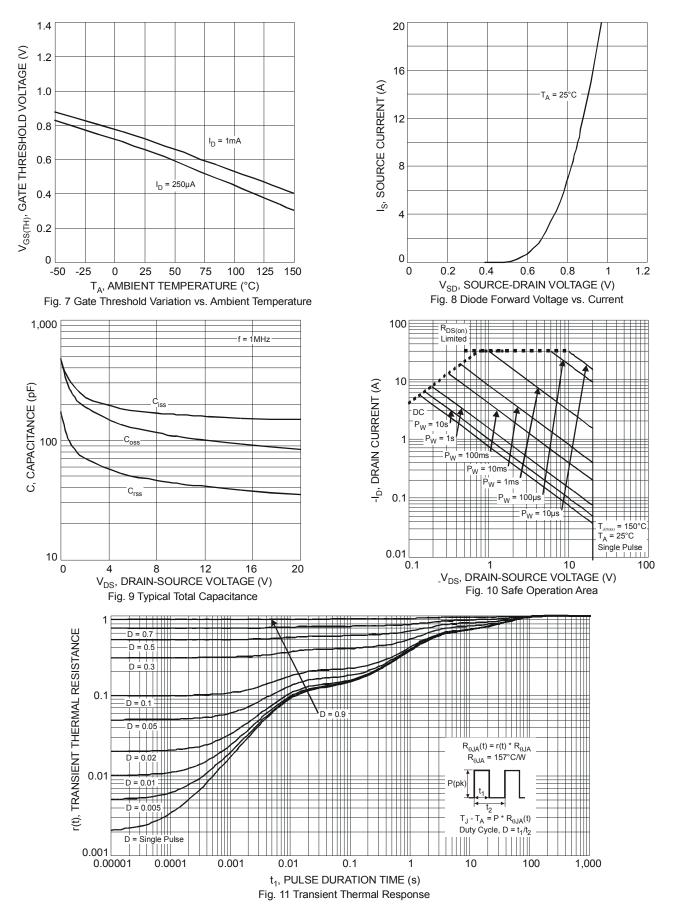


Fig. 6 On-Resistance Variation with Temperature

Fig. 5 On-Resistance Variation with Temperature

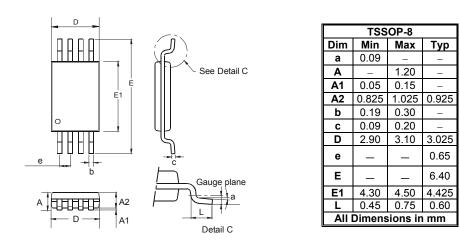






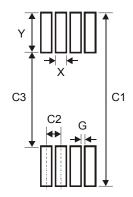
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) | | | | |
|------------|---------------|--|--|--|--|
| X | 0.45 | | | | |
| Y | 1.78 | | | | |
| C1 | 7.72 | | | | |
| C2 | 0.65 | | | | |
| C3 | 4.16 | | | | |
| G | 0.20 | | | | |



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